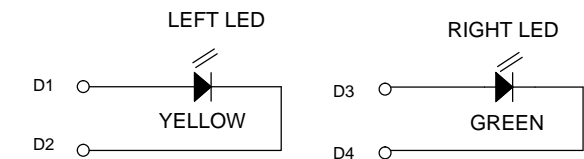


1. Notes:

- 1.Meets for exceeds IEEE802.3 standards.
- 2.Materials:
 - 2.1.RJ45Housing : Thermo plastics,PBT ,BK,UL94V-0.
 - USB Housing: Thermo plastics,PBT ,Blue,UL94V-0.
 - 2.2.Insert Base : Thermo plastics.PBT.BK.UL94V-0.
 - 2.3.Contact : Phosphor Copper
 - 2.4.Shell : C2680 . 30u Min Nickel plating overall.
 - 2.5.RJ45 Terminal material : C5191-EH.
- Plating specification :
 - Gold plating Flash on contact area.;
 - 30u" min Ni underplating over all;
 - 80u"tin Plating on solder tail area.
- 2.7.USB Terminal material : C2680.
- Plating specification :
 - Gold plating Flash on contact area;
 - 30u" min Ni underplating over all;
 - 80u"tin Plating on solder tail area.
- 3.Operating Temperature:-40°C to +85°C.
- 4.Storage Temperature:-40°C to +85°C.

2.LED Information:



ORDER CODE: A-MJU-8-DA-xTP-S2

- K:Gold flash selective tin
- P: Au15µ" selective tin
- H: Au30µ" selective tin

RoHS compliant
Unit: mm

| | | | | | | | | | | |
|---|-----------|-------|-----|--------------|------------|----------|------------|------|--------------------------------|--|
| G | Scale | Free | | | | | Date | Name | Description: Modular Connector | |
| | TOLERANCE | | | | | Drawn | 06.01.2022 | Luca | RJ45 Jack + USB3.0 AF | |
| | X.X | ±0.38 | | | | Approved | 06.01.2022 | Luca | ASSMANN WSW-No. | |
| | X.XX | ±0.25 | | | | | | | A-MJU-8-DA-xTP-S2 | |
| H | X.XXX | ±0.13 | | | | | | | Drawing-No. | |
| | DIM | TOL | | | | | | | ASS 9197 CO | |
| | Angle | TOL | ① | Drawn | 06.01.2022 | Luca | | | rev00 | |
| | | | Id. | Modification | Date | Name | | | Customer-No. | |